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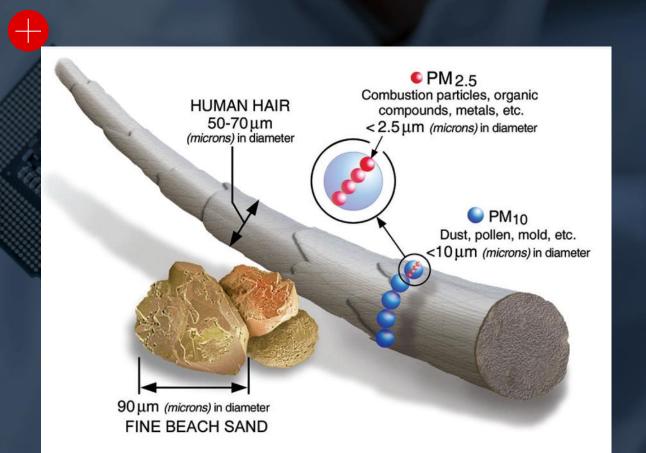
Chris Jones, Terry Chang and Shou-Nan Li

PARTICULATE CONTAMINATION IS FREQUENTLY CREATED BY SEMICONDUCTOR PROCESSES.

Sometimes the equipment used to treat process gases from the manufacturing tool also creates particles. For example, the abatement of silane, which is used to deposit thin silicon films, creates a dust of fine particles of amorphous silicon dioxide.

This dust can impact not only the operation of the FAB, but also the health of both the employees and the public.

Environmental scientists refer to particle size categories as PM 10, PM 2.5 and PM 1, meaning particles less than $10\mu m$, less than $2.5\mu m$ and less than $1\mu m$ respectively.



CURRENT REGULATIONS IN TAIWAN

Specifying limits for total suspended particles, PM 10 and PM 2.5.

POLLUTANT	AVERAGING TIME	LEVEL HG/M3
Total Suspended Particles (TSP)	24 hours	250
	Annual geometric average	130
Size equivalent less than 10 μm	24 hours	125
	Annual geometric average	65
Size equivalnt less than 2.5 µm	24 hours	35
	Annual geometric average	15

POISON IN THE AIR WE BREATHE 3 Travels deep into - Actual size of a human hair luman hair enlarged PM2.5 Fine particulate stream trace matter (PM2.5) 2 Enters metals can cause Size comparison interior cancer and even to hair genetic illness in later generations PM2.5 pollution level Can be five or six times higher in Trace metals level Trace metals frequently found in China's air pollution include copper, magnesium, lithium, nickel, cobalt, arsenic

FAB OPERATION DOWNTIME

The mentioned dust can block ducts, leading to expensive downtime. Dust released within the fab during maintenance can damage both the manufacturing equipment and the silicon wafer products. Good dust control is needed to maximise facility uptime.

Although this oxide dust is relatively non-toxic, the health hazards associated with inhaling the powder increase with decreasing particle size.

HEALTH IMPLICATIONS

Small particles are potentially hazardous to health because they can enter the body through the airways and lungs. PM 2.5 and PM 1 particles can get into fine lung structures, leading to reduced lung function. PM 0.1 can penetrate even further, and may lead to cancers and cardiovascular failure through inflammation.

Good dust control is also needed to minimise health, safety, and environmental issues. The table to the right summarises ambient regulatory limits in Taiwan, for total suspended particles (TSP), PM 10 and PM 2.5.

Regulations typically specify stack emissions to control exposure of the public beyond the perimeter fence to hazardous compounds. Toxicity of dusts, stack height, and distance to the perimeter are important considerations when establishing these limits.

The table provides an indication of emission limits for some solid compounds comprising elements of interest to the semiconductor industry. The drive to reduce particulate hazards motivates the development of not only the abatement equipment, but also rigorous analytical methods that can be readily applied in the field for both point of use (POU) and end of pipe (EOP) measurements.

MEASUREMENT AND METHODOLOGY

Any measurement technique used to monitor emissions and improve performance at the system level must:

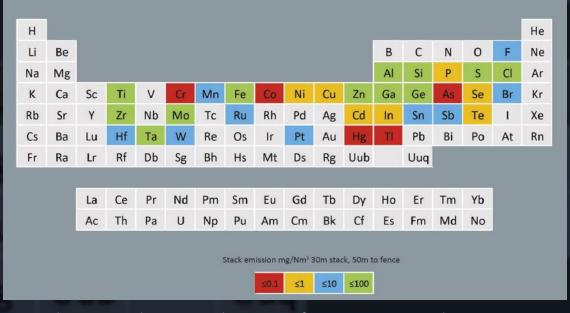
- Use methods that are recognised internationally
- Be portable enough to move easily from system to system
- Be easily installed in and compatible with the fab/sub-fab operating environment and able to test both point-of-use (POU) or end-of-pipe (EOP) equipment
- Follow best practices for sampling in duct sampling is best and any sample lines must be kept short
- Measure PM 2.5 and TSP
- Measure concentration, mass flow, and composition

In a recently published work, Shou-Nan Li and his colleagues at ITRI described a measurement methodology and its use in measuring particulate releases from an Edwards Atlas system for abating silane flows of 1, 0.5 and 0 slm.



PERMITTED LEVELS OF EMISSION OXIDES

for toxic elements in semiconductor manufacture.



Many elements used in semiconductor manufacturing are toxic. Colour coding here indicates permitted emission levels of their oxides.

THE EDWARDS ATLAS ATOMISING SPRAY TOWER



Exhaust

Air cyclone

Atomising sprays (fresh water)

Water spray nozzle (recirculated water)

High surface area packing material

Packing support tray





Left: the exhaust after 30 days of use without ATMS. *Right:* 120 days use <u>with</u> ATMS.

The **Atlas** alone removes approximately 60% of solids. With the built-in atomising spray tower, the total powder removal rate increases to »75%.

It also maintains pack tower irrigation and scrubbing efficiency, avoiding excessive mist carryover to the exhaust, which then travels to the optional *Wet Electrostatic Precipitator* (WESP).

HOW ADDING A WESP TO THE PROCESS DRAMATICALLY IMPROVED THE OUTCOMES

With the addition of an optional WESP, the overall system particle removal efficiency improves to ~99.9%.

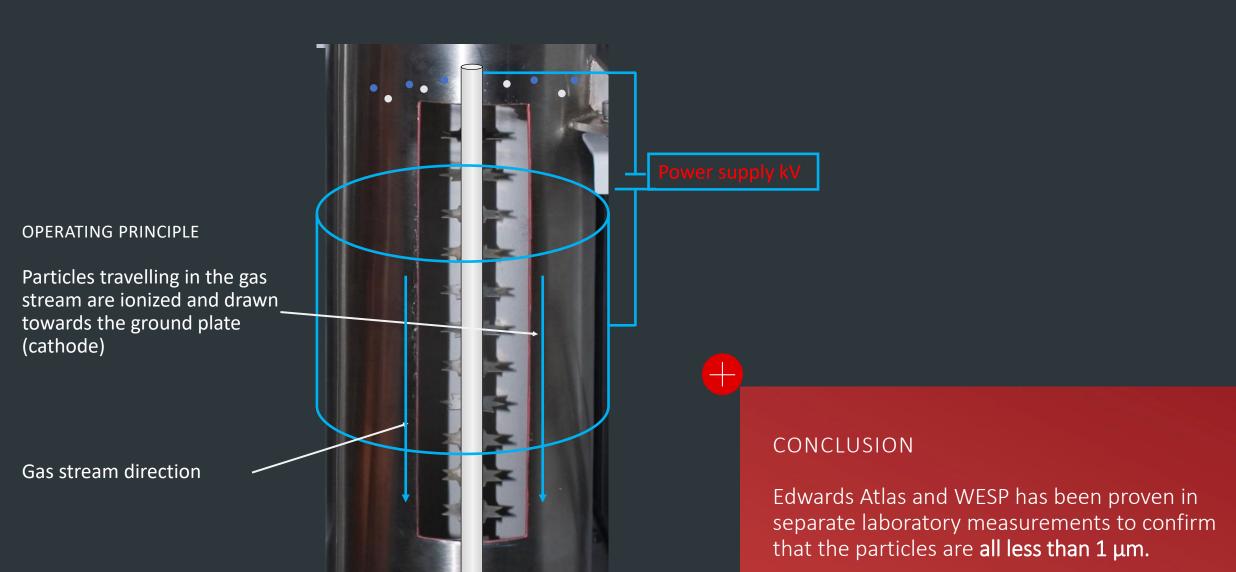
At 1slm input silane, releases from the **Atlas and WESP** were $^{\sim}$ 2mg/m3. Under the same conditions, mass releases from the Atlas alone would be $^{\sim}$ 1.5 kg/d, but the addition of the WESP would reduce this to only 3-4 g/day.

The agreement of the total suspended particulate and PM2.5 measurements confirmed that the particulate released were all no more than 2.5 μ m in diameter. Separate laboratory measurements have since confirmed that the particles *are all less than 1 \mum*.



A WESP was added to the Edwards Atlas abatement system to .

HOW THE WET ELECTROSTATIC PRECIPITATOR (WESP) WORKS





[environments where innovation thrives]